

# Pneumatic glue guns

# 004

The application devices of the HB 720 series are optimised for high melting capacities. Three heating cartridges with a total output of 600 watts ensure that the tank, nozzle and cap are heated quickly and evenly. The shape, weight and ergonomics were developed for fatigue-free work. The devices have a new, patented and unique level control, which reliably indicates when to refill hot-melt adhesive.

## HB 720 bead



### HB 720 – Dot and bead application

The universal hand-held device for manual applications in a professional environment. It enables extreme productivity without the outlay for automation. Hot-melt adhesives in the form of granules, pillows or cartridges (43 mm) can be processed in the tank.

### Advantages and equipment features HB 720 Bead

- › Process reliability through continuously adjustable temperature control +/- 1 °C
- › Integrated level control and thus extremely efficient operation
- › One-hand bayonet lock for optimum ease of use
- › Ergonomically-shaped handle for fatigue-free work
- › Automatic temperature lowering for economical energy consumption and protection of the hot-melt adhesive
- › Temperature control with digital display integrated in the handle
- › Incl. conical nozzle standard Ø 1.5 mm

### Technical data

Dimensions . . . . . 300 x 270 x 107 mm  
Weight . . . . . 1.35 kg  
Operating voltage . . . . . 220-230 V, 50 Hz  
Power consumption . . . . . 600 W  
Working temperature . . . . . 40-210 °C  
Capacity . . . . . 200 ml  
Melting capacity . . . . . for cartridges 3.2 kg/h, for granules 1.3 kg/h\*



\* Depending on temperature and adhesive viscosity

## HB 720 spray



### HB 720 Spray

If materials have to be bonded together over a large area, the spray version is selected. With the spray version of the HB 720, different spray applications patterns can be realised. The spray pattern is changed by regulating the spray air. The device is particularly suitable for processing pressure-sensitive hot-melt adhesives.

### Differing advantages and equipment features HB 720 Spray

- › Wafer-thin spray film and thus lower consumption of hot-melt adhesive
- › Process reliability through a consistent spray pattern
- › Inc. swirl nozzle with a standard diameter of Ø 1.5 mm
- › Large-area application
- › Suitable for bonding heat-sensitive materials
- › Conversion to a bead version is possible if required
- › Also ideal for securing pallets at changing workplaces

### Technical data

Dimensions . . . . . 280 x 270 x 107 mm  
Weight . . . . . 1.5 kg  
Operating voltage . . . . . 220-230 V, 50 Hz  
Power consumption . . . . . 600 W  
Working temperature . . . . . 40-210 °C  
Capacity . . . . . 200 ml  
Melting capacity . . . . . for cartridges 3.2 kg/h, for granules 1.3 kg/h\*

